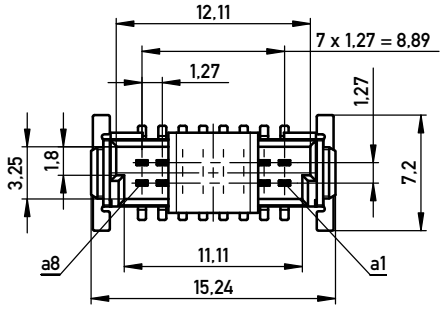
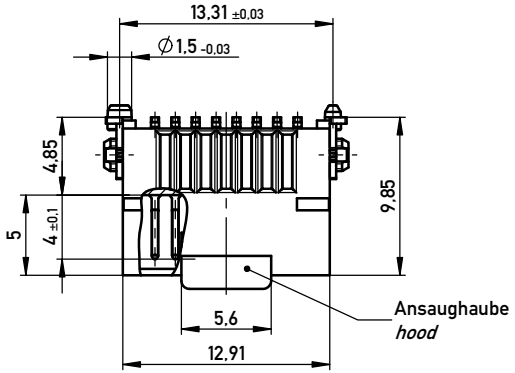
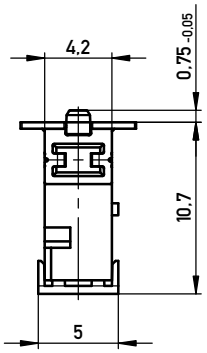








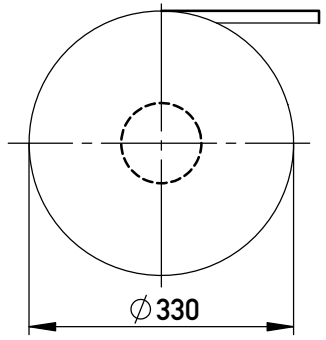
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

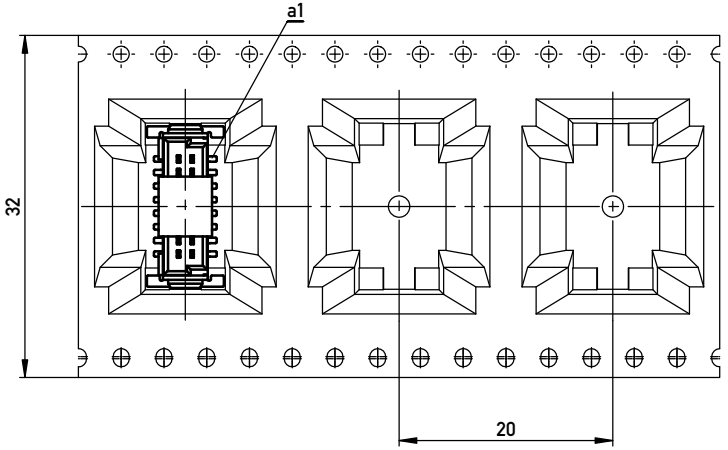
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

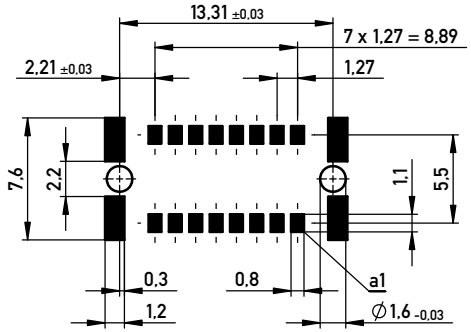
Verpackt in Gurtverpackung
Tape on Reel Packaging
Verpackungseinheit: 250 Stück
Packaging unit: 250 pcs



Abspulrichtung - *Reel off Direction*



Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



BA 8-23 - hohe Bauhöhe
type 8-23 - High Profile

Information:	Tolerances	All Dimensions in mm	Scale 3:1

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Subject to modification without prior notice.
Drawing will not be updated.

Designation
Messerl. SMC-Q 16-SMD-BA8-23
Male SMC-Q 16-SMD-type8-23

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d		17.07.2013	
Index		Date	

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A3
Class SMCQ